

RECOMMENDABLE CONDITION OF SOLDERING

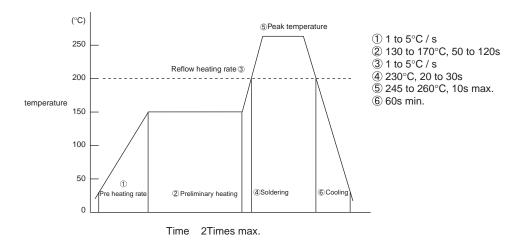
SURFACE MOUNTED DEVICE

CONDITION OF SOLDERING FOR SURFACE MOUNTED DEVICE (DISCRETE DIODES) LEAD FREE (Sn-3Ag-0.5Cu) VERSION

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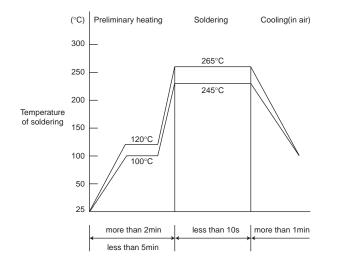
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• Recommended condition of reflow soldering



Recommended peak temperature is over 245 C. If peak temperature is below 245 C, you may adjust the following parameters ; Time length of peak temperature (longer), Time length of soldering (longer), Thickness of solder paste (thicker).

Flow soldering

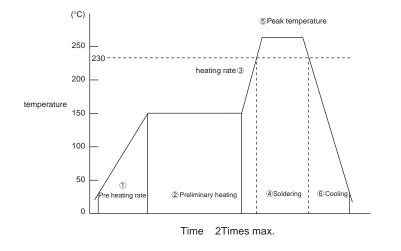


• Condition of hand soldering

Temperature	refer to right table
Time	less than 3s
Times	one time

Temperature differ from PKG	
PKG less than 400°C SMD3, SMD4, SMD5, SMD6, SSD3, UMD2(expect for 1SS355, 1SS380, 1SS376, UDZ S series) UMD3, UMD3F, UMD4, UMD5, UMD6, EMD2, EMD3, EMD3F, EMD4, EMD5, EMD6, VMN2, VMD2, VMD3, GMD2 HMD8, HMD12, LLDS, LLDL	
PKG less than 350°C UMD2(1SS355, 1SS380, 1SS376, UDZ S series) KMD2, TUMD2, TUMD5, TSMD5, TSMD6 TSMD8, PMDU, PMDS, PMDT, MPD, CPD3, LPDS	

• Condition of heat-resistant



1 to 5°C / s
150 to 180°C, 60 to 120s
1 to 5°C / s
230°C, 20 to 40s
260°C max, 10s max.
60s min.

• Recommended condition of washing

1. Washing liquid

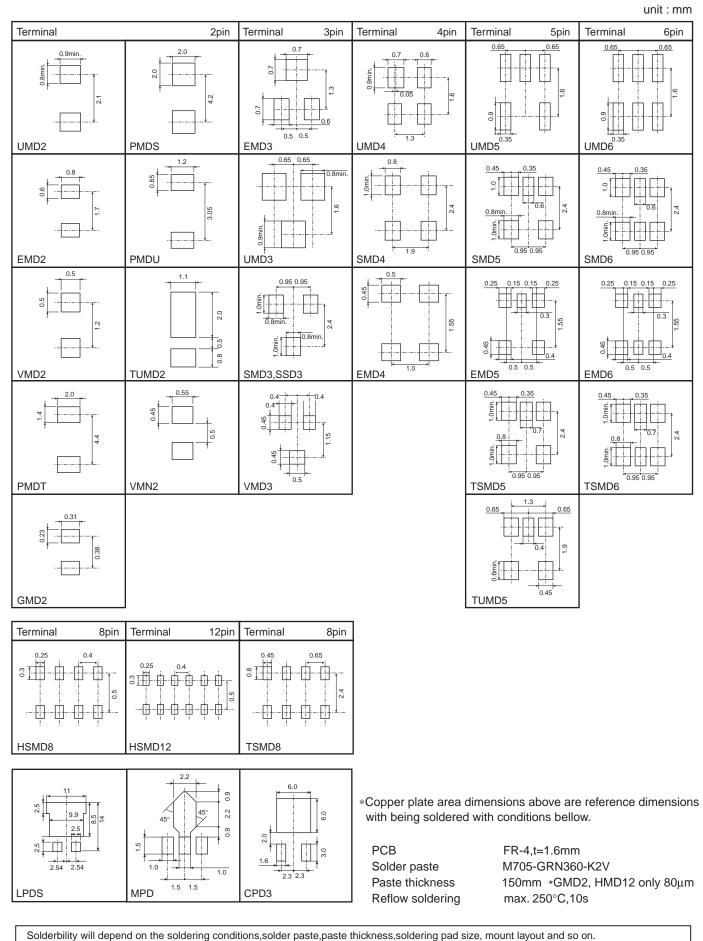
washing liquid	manufacturers
water	-
ethanol	_
methanol	_
pine alpha ST-100S	ARAKAWA CHEMICAL
clean through 750H	КАО
technocare FRW-1	TOSHIBA TECHNOCARE
mighty solve AH-V	ASAHI GLASS

2. Condition of washing

was	hing bath	time	temperature	remarks
first bath	ultrasonic bath	less than 60s	room temperature	25 to 28kHz, 15W / L
second bath	immersion bath	less than 60s	room temperature	
third bath	vaper bath $*$	less than 60s	less than 44.7°C	boiling points differ to washing liquid

* In vaper bath, you can not use ethanol , methanol and water due to their high boiling points.

RECOMMENDABLE CONDITION OF SOLDERING



So, it is difficult for ROHM to refer to customer's soldering conditions.

Optomize footprint dimensions to the board design and soldering conditions.

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